

Applicant Information

Applicant Authority Type::	Inventor
Applicant One Given Name::	Chih-Tsung
Family Name::	Lin
Postal Address Line One::	No. 16, Wuling Rd. 179
City::	Hsinchu
Country::	Taiwan, R.O.C.
Postal or Zip Code::	300
Country of Residence::	Taiwan, R.O.C.
Citizenship Country::	Taiwan, R.O.C.

Correspondence Information

Correspondence Customer Number:: 000027683

Application Information

Title Line One::	A KNOWLEDGE SLICING AND ENCAPSULATING
Title Line Two::	METHOD IN A SEMICONDUCTOR
Title Line Three::	MANUFACTURING SYSTEM
Total Drawing Sheets::	15
Formal Drawings?::	No
Application Type::	Utility
Docket Number::	24061.60 (TSMC2003-0191)

Representative Information

Registration Number::	42,044
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Assignee Information

Assignee Name::	Taiwan Semiconductor Manufacturing Co., Ltd.
Street of mailing address::	No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park
City::	Hsin-Chu
State or Province::	Taiwan, R.O.C.
Country of mailing address::	Taiwan, R.O.C.
Postal or Zip Code::	300-77

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